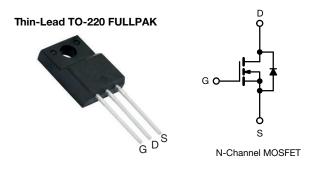
**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> max (Ω). at 25 °C	$V_{GS} = 10 V$	0.18			
Q <sub>g</sub> max. (nC)	86				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	24				
Configuration	Single				

## **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-Intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer
  - Adaptors
  - Televisions
  - Game console
- Computing
  - Adaptors
  - ATX power supply

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA22N60E-E3			
Lead (Pb)-free and halogen-free	SiHA22N60E-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	N	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T <sub>.1</sub> = 150 °C) $^{\circ}$	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		8		
Continuous drain current $(I_J = 150 \text{ C})^\circ$	VGS AL TO V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	5	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	56		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	367	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$T_J = T_J$	125 °C	-IV / / -I+	70		
Reverse diode dV/dt <sup>d</sup>			dV/dt	11	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 5.1$  A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

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DADAMETED	SVMDOI	TVD	l	MAY			LINUT	
PARAMETER	SYMBOL	TYP.			MAX.		UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		65		°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.6						
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static		1			1	1	1	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	<sub>D</sub> = 250 μA	-	0.71	-	V/°
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
			$V_{GS} = \pm 20$	V	-	-	± 100	n/
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zere gete veltege drein eurrent		V <sub>DS</sub> =	= 600 V, V <sub>G</sub>	<sub>iS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 \	/, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I	<sub>D</sub> = 11 A	-	0.15	0.18	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 8 V, I <sub>D</sub> = 5 A		-	6.4	-	S	
Dynamic		-				-		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1920	-	pF	
Output capacitance	C <sub>oss</sub>			-	90	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\text{DS}}$ = 0 V to 480 V, $V_{\text{GS}}$ = 0 V		-	73	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	263	-		
Total gate charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 11 \text{ A}, V_{DS} = 480 \text{ V}$		-	57	86	nC	
Gate-source charge	Q <sub>gs</sub>			-	11	-		
Gate-drain charge	Q <sub>gd</sub>			-	24	-		
Turn-on delay time	t <sub>d(on)</sub>				-	18	36	
Rise time	t <sub>r</sub>	$V_{DD}=380~\text{V},~\text{I}_{D}=11~\text{A},\\ V_{GS}=10~\text{V},~\text{R}_{g}=4.7~\Omega$		-	27	54	ns	
Turn-off delay time	t <sub>d(off)</sub>			-	66	99		
Fall time	t <sub>f</sub>			-	35	70		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.3	0.77	1.2	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21		
Pulsed diode forward current	I <sub>SM</sub>			-	-	56	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 11 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	٧
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dI/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	344	-	n	
Reverse recovery charge	Q <sub>rr</sub>			-	5.3	-	μ(	
Reverse recovery current	I <sub>RRM</sub>			-	28	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

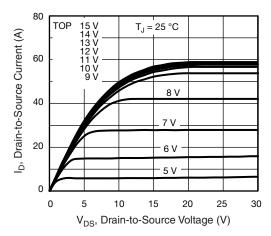


Fig. 1 - Typical Output Characteristics

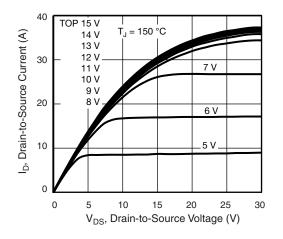
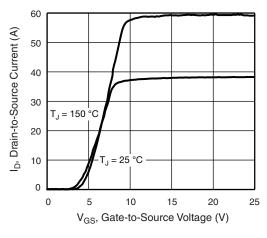


Fig. 2 - Typical Output Characteristics





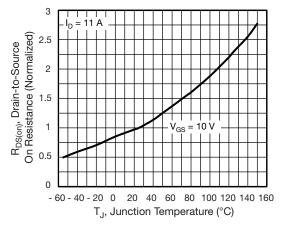


Fig. 4 - Normalized On-Resistance vs. Temperature

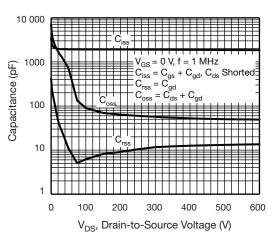


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

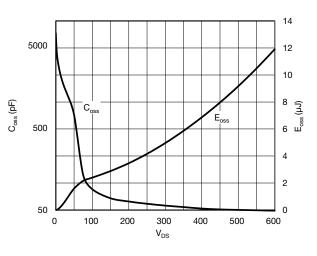


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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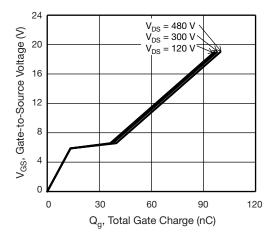


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

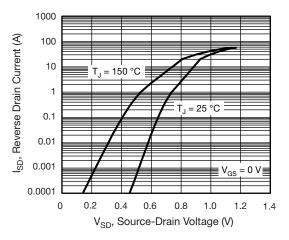


Fig. 8 - Typical Source-Drain Diode Forward Voltage

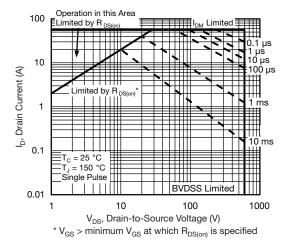


Fig. 9 - Maximum Safe Operating Area

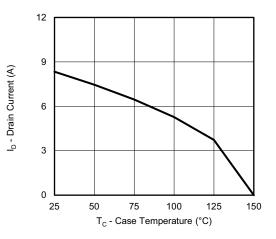


Fig. 10 - Maximum Drain Current vs. Case Temperature

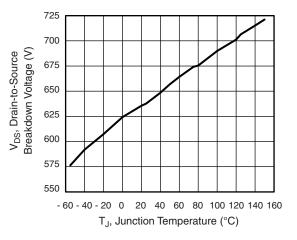


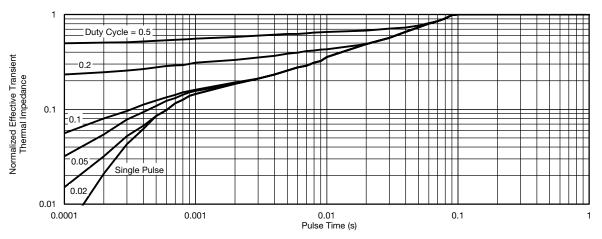
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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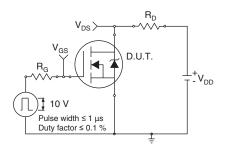


Fig. 13 - Switching Time Test Circuit

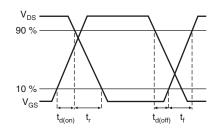


Fig. 14 - Switching Time Waveforms

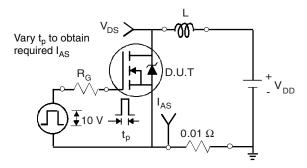


Fig. 15 - Unclamped Inductive Test Circuit

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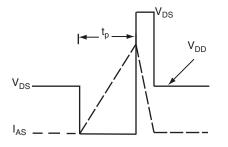


Fig. 16 - Unclamped Inductive Waveforms

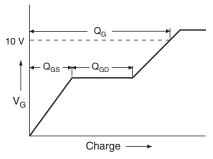


Fig. 17 - Basic Gate Charge Waveform



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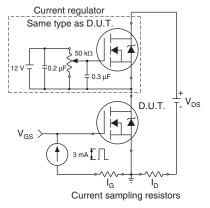


Fig. 18 - Gate Charge Test Circuit



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#### Peak Diode Recovery dV/dt Test Circuit

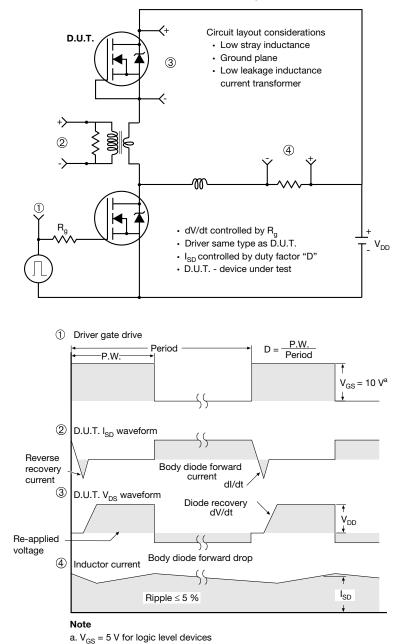


Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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